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**TS04** 

4-Channel Self Calibration Capacitive Touch Sensor

SPECIFICATION V3.0

WWW

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ADSemiconductor

#### TS04 (4-CH Auto Sensitivity Calibration Capacitive Touch Sensor)

#### **Specification** 1

#### 1.1 General Feature

- 4-Channel capacitive sensor with auto sensitivity calibration
- Parallel output interface
- Independently adjustable sensitivity with external capacitor
- Adjustable internal frequency with external resister
- Embedded high frequency noise elimination circuit
- Low current consumption
- RoHS compliant 16QFN, 14SOP package

#### 1.2 Application

- Mobile application (mobile phone / PDA / PMP MP3 etc)
- Membrane switch replacement
- Sealed control panels, keypads
- Door key-lock matrix application

### 1.3 Package (16 QFN / 14SOP)



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#### TS04 (4-CH Auto Sensitivity Calibration Capacitive Touch Sensor)

### 2 Pin Description

#### 2.1 16 QFN package

PIN No.		Name	Ι/Ο	Description	Protection
	1	N.C.	_	Not connect	-
	2	RBIAS	Analog Input	Internal bias adjust input	VDD/GND
	3	GND	_	Connect to GND	VDD/GND
	4	CS1	Analog Input	CH1 capacitive sensor input	VDD/GND
	5	CS2	Analog Input	CH2 capacitive sensor input	VDD/GND
	6	CS3	Analog Input	CH3 capacitive sensor input	VDD/GND
	7	Dummy	Analog Input	Internal noise monitoring input Do not connect to anywhere	VDD/GND
	8	GND	Ground	Supply ground	VDD
/-	9	CS4	Analog Input	CH4 capacitive sensor input	VDD/GND
J.	10	OUT1	Digital Output	Output1 for CS1 (Open Drain structure)	VDD/GND
TEL.	11	OUT2	Digital Output	Output2 for CS2 (Open Drain structure)	VDD/GND
	12	GND	Ground	Supply ground	VDD
	13	OUT3	Digital Output	Output3 for CS3 (Open Drain structure)	VDD/GND
	14	OUT4	Digital Output	Output4 for CS4 (Open Drain structure)	VDD/GND
	15	GND	_	Connect to GND	VDD/GND
	16	VDD	Power	Power (2.5V~5.0V)	GND

#### TS04 (4-CH Auto Sensitivity Calibration Capacitive Touch Sensor)

#### 2.2 14 SOP

	PIN No. Name I/O		I/O	Description	Protection	
	1	GND	_	Connect to GND	VDD/GND	
	2	VDD	Power	Power (2.5V~5.0V)	GND	
	3	RBIAS	Analog Input	Internal bias adjust input	VDD/GND	
	4	CS1	Analog Input	CH1 capacitive sensor input	VDD/GND	
	5	CS2	Analog Input	CH2 capacitive sensor input	VDD/GND	
	6	CS3	Analog Input	CH3 capacitive sensor input	VDD/GND	
	7	Dummy	Analog Input	Internal noise monitoring input Do not connect to anywhere	VDD/GND	
	8	GND	Ground	Supply ground	VDD	
	9	CS4	Analog Input	CH4 capacitive sensor input	VDD/GND	
314	10	OUT1	Digital Output	Output1 for CS1 (Open Drain structure)	VDD/GND	
	115	OUT2	Digital Output	Output2 for CS2 (Open Drain structure)	VDD/GND	
TEL.	12	GND	Ground	Supply ground	VDD	
	13	OUT3	Digital Output	Output3 for CS3 (Open Drain structure)	VDD/GND	
	14	OUT4	Digital Output	Output4 for CS4 (Open Drain structure)	VDD/GND	

#### TS04 (4-CH Auto Sensitivity Calibration Capacitive Touch Sensor)

### 3 Absolute Maximum Rating

Battery supply voltage	5.0V
Maximum voltage on any pin	VDD+0.3
Maximum current on any PAD	100mA
Power Dissipation	800mW
Storage Temperature	-50 ~ 150℃
Operating Temperature	-20 ~ 75℃
Junction Temperature	150℃
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Note Unless any other command is noted, all above are operated in normal temperature.

#### ESD & Latch-up Characteristics 4

Mode	Polarity	Minimum Level	Reference
	IF The	5000V	VDD
H.B.M	Pos / Neg	3000V	VSS
T	Jarsh 610 C	3 5000V	P to P
	10 -5	500V	VDD
M.M	Pos / Neg	300V	VSS
A ES	V.V. WW	500V	P to P
C.D.M	Pos / Neg	500V	DIRECT
• • • • •	r us / Neg	₩ 800V	DINECT
<b>)</b>	$X \setminus J \to X \vee X \vee X$		

#### 4.1 **ESD Characteristics**

#### 4.2 Latch-up Characteristics

Mode	Polarity	Minimum Level	Test Step
LTeet	Positive	200mA	25mA
l Test	Negative	-200mA	25MA
V supply over 5.0V	Positive	8.0V	1.0V

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#### **Electrical Characteristics** 5

• $V_{DD}$ =3.3V, Rb=510k, Sync Mode (Rsync = 2M $\Omega$ ) (Unless otherwise noted), T <sub>A</sub> = 25 °C
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Characteristics	Symbol	Test Condition	Min	Тур	Мах	Units
Operating supply voltage	V <sub>DD</sub>		2.5	3.3	5.0	V
Current concurrention	I	$V_{DD}$ = 3.3V R <sub>B</sub> =510k R <sub>SB</sub> =0	_	40.	70	25
Current consumption	I <sub>DD</sub>	$V_{DD}$ = 5.0V R <sub>B</sub> =510k R <sub>SB</sub> =0	. 1.	80	140	A
Digital output maximum sink current	I <sub>OUT</sub>	T <sub>A</sub> = 25℃ (Normal I2C Output)			4.0	mA
Internal reset criterion V <sub>DD</sub> voltage	V <sub>DD_RST</sub>	$T_{A} = 25^{\circ}c, R_{B} = 510k$	-2	<u>)</u>	0.3·V <sub>DD</sub>	V
Sense input capacitance range [Note1]	Cs	ENK OF S	32	3	0100	pF
Minimum detective capacitance difference	7-AC	Cs = 10pF	0.2			рF
Output impedance		$\Delta C > 0.2 pF, Cs = 10 pF$	<u> </u>	12		Ω
(open drain)	Zo	$\Delta C < 0.2 pF$ , Cs = 10 pF	LEL.	30M	_	22
Self calibration time	4.	$V_{DD} = 3.3 V R_B = 510 k$	17	100	_	~ ~
after system reset	TCAL	$V_{DD} = 5.0V R_B = 510k$	_	80	_	ms
Sense input resistance range	Rs	山集的	_	200	1000	Ω
Recommended bias	X	V <sub>DD</sub> = 3.3V	200	510	820	1.0
resistance range [Note2]	HB	$V_{DD} = 5.0 V$	330	620	1200	kΩ

Note 1 : The sensitivity can be increased with lower  $C_{\text{S}}$  value.

The recommended value of  $C_{\text{S}}$  is 10pF when using 3T PC(Poly Carbonate) cover and 10 mm x 7 mm touch pattern.

Note 2 : The lower  $\mathsf{R}_\mathsf{B}$  is recommended in noisy condition.

#### TS04 (4-CH Auto Sensitivity Calibration Capacitive Touch Sensor)

- Implementation of TS04 6
- 6.1 RBIAS & SRBIAS implementation



Normal operation current consumption curve

The current consumption curve of TS04 is represented in accordance with R<sub>B</sub> value as above. The lower R<sub>B</sub> requires more current consumption but it is recommended in noisy application. For example, refrigerator, air conditioner and so on.

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TS04 (4-CH Auto Sensitivity Calibration Capacitive Touch Sensor)

#### 6.2 CS implementation



The TS04 has available sensing channel up to 4. The parallel capacitor  $C_{S1}$  is added to CS1 and  $C_{S4}$  to CS4 to adjust fine sensitivity. The sensitivity would increase when a smaller value of  $C_S$  is used. (Refer to the below Sensitivity Example Figure) It could be useful in case detail sensitivity mediation is required. The internal touch decision process of each channel is separated from each other. The four channel touch key board application can therefore be designed by using only one TS04 without coupling problem. The R<sub>S</sub> is serial connection resistor to avoid malfunction from external surge and ESD. (It might be optional.) From 200 $\Omega$  to 1k $\Omega$  is recommended for R<sub>S</sub>. The size and shape of PAD might have influence on the sensitivity. The sensitivity will be optimal when the size of PAD is approximately an half of the first knuckle (it's about 10 mm x 7 mm). The connection line of CS1 ~ CS4 to touch PAD is recommended to be routed as short as possible to prevent from abnormal touch detect caused by connection line.

There are some sensitivity difference among CS1, CS2 and CS3, and CS4 caused by internal parasitic capacitance. That sensitivity difference could be compensated by using different  $C_S$  capacitor or sensitivity setting with internal register. To use different touch pattern area could be used for sensitivity compensation but not recommended. The sensitivity of each channel can be represented as below.

Sensitivity of CS1  $\geq$  Sensitivity of CS2, CS3 > Sensitivity of CS4 (In case of the external parasitic capacitance value is same on each channel.)

 $C_{CS1_{PARA}}$  + about 3.5pF =  $C_{CS2,3_{PARA}}$  + about 3pF =  $C_{CS4_{PARA}}$ 

- \* C<sub>CS1 PARA</sub> : Parasitic capacitance of CS1
- \* C<sub>CS2,3\_PARA</sub> : Parasitic capacitance of CS2 and CS3
- \* C<sub>CS4\_PARA</sub> : Parasitic capacitance of CS4

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#### TS04 (4-CH Auto Sensitivity Calibration Capacitive Touch Sensor)

#### 6.3 Output Circuit Implementation



The OUTPUT pins have an open drain structure. For this reason, the connection of pull-up resistor R<sub>OUT</sub> is required between OUTPUT and VDD. The maximum output sink current is 4mA, so over a few  $k\Omega$  must be used as  $R_{OUT}$ . Normally  $10k\Omega$  is used as  $R_{OUT}$ .

The OUTPUT is high in normal situation, and the value is low when a touch is detected on the corresponding CS.

#### 6.4 Internal reset operation

The TS04 has stable internal reset circuit to offer reset pulse to digital block. The supply voltage for a system start or restart should be under 0.3·V<sub>DD</sub> of normal operation V<sub>DD</sub>. No external components required for TS04 power reset, that helps simple circuit design and to realize the low cost application.

#### TS04 (4-CH Auto Sensitivity Calibration Capacitive Touch Sensor)

#### **Recommended Circuit Diagram** 7

#### **Application Example (16QFN)** 7.1



TS04(16QFN) Application Example Circuit

- In PCB layout, RB should not be placed on touch pattern. The RB pattern should be routed as short as possible.
- The CS patterns also should be routed as short as possible and the width of line might be about 0.25mm (or narrower line).
- The capacitor that is between VDD and GND is an obligation. It should be located as close as possible from TS04.
- The CS pattern routing should be formed by bottom metal (opposite metal of touch PAD).
- The empty space of PCB must be filled with GND pattern to strengthen GND pattern and to **.** prevent external noise from interfere with sensing frequency.
- The TS04 is reset when power rise from 0V to proper VDD

#### TS04 (4-CH Auto Sensitivity Calibration Capacitive Touch Sensor)

- The VDD periodic voltage ripple over 50mV and the ripple frequency is lower than 10 kHz can 4 cause wrong sensitivity calibration. To prevent above problem, power (VDD, GND) line of touch circuit should be separated from other circuit. Especially LED driver power line or digital switching circuit power line certainly should be treated to be separated from touch circuit.
- The smaller R B is recommended in noisy environments.
- About 200Ω Resistor (RS1~RS4) and parallel capacitor (CS1~CS4) is might be inserted to improve external noise immunity.
- Parallel capacitor value effects on touch sensitivity.
- The LED\_GND and GND should be short in the system and the lines are recommended to be 4 split from the most low impedance ground point to avoid ground bouncing problems.

#### 7.2 Application Example (14 SOP)



TS04(14 SOP) Application Example Circuit

#### TS04 (4-CH Auto Sensitivity Calibration Capacitive Touch Sensor)

#### 7.3 Example – Power Line Split Strategy PCB Layout

#### A. Not split power line (Bad power line design)



- The noise that is generated by AC load or relay can be loaded at 5V power line.
- 4 A big inductance might be appeared in case of the connection line between main board and display board is too long, moreover the voltage ripple could be generated by LED (LCD) display driver at VDD (5V).

B. Split power line (One 5V regulator used) – Recommended



#### C. Split power line (Separated 5V regulator used) - Strongly recommended



#### TS04 (4-CH Auto Sensitivity Calibration Capacitive Touch Sensor)

#### **MECHANICAL DRAWING** 8

#### 8.1 Mechanical drawing (16 QFN)







TS04 (4-CH Auto Sensitivity Calibration Capacitive Touch Sensor)

### 8.2 Mechanical Drawing (14 SOP)

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NOTES:

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